



MBC13916

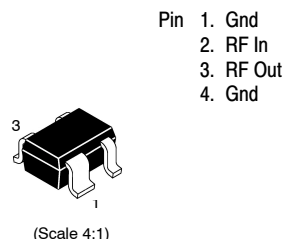
The RF Building Block Series General Purpose SiGe:C RF Cascode Amplifier

The MBC13916 is a cost-effective, high isolation amplifier fabricated with Motorola's Advanced RF BiCMOS process using the SiGe:C module. It is intended to be a similar replacement for the MRFIC0916 and is housed in the smaller SOT-343R surface mount package. As with the MRFIC0916, the device is designed for general purpose RF applications, but has improved high frequency gain and noise figure. On-chip bias circuitry sets the bias point, while matching is accomplished off-chip, affording the maximum in application flexibility.

- Usable Frequency Range = 100 to 2500 MHz
- 19 dB typical gain at 900 MHz, $V_{CC} = 2.7$ V
- NF_{min} (Device Level) = 0.9 dB @ 900 MHz
- NF_{min} (Device Level) = 1.9 dB @ 1.9 GHz
- 2.5 dBm typical Output Power at 1.0 dB Gain Compression at 900 MHz, $V_{CC} = 2.7$ V
- 45 dB Typical Reverse Isolation (Device Level) at 900 MHz, $V_{CC} = 2.7$ V
- 4.7 mA Typ Bias Current at $V_{CC} = 2.7$ V
- 2.7 to 5.0 V Supply
- Industry Standard SOT-343R Package
- Available Only in Tape and Reel Packaging
- Device Weight = 0.00642 g (Typ)

GENERAL PURPOSE SiGe:C RF CASCODE AMPLIFIER

SEMICONDUCTOR TECHNICAL DATA

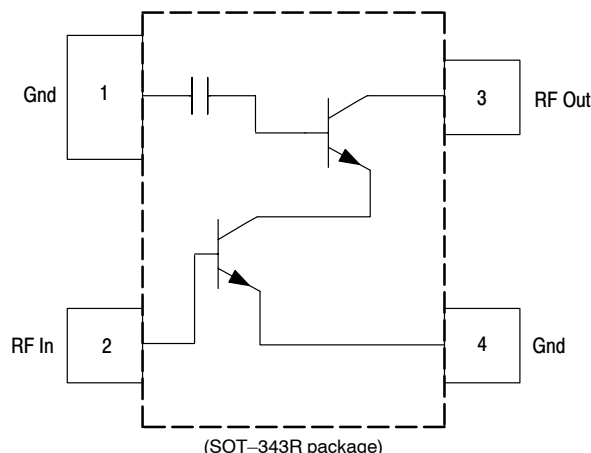


PLASTIC PACKAGE
SOT-343R
(Tape & Reel Only)

ORDERING INFORMATION

Device	Device Marking	Package
MBC13916T1	916	SOT-343R

Functional Block Diagram



MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise noted)

Rating	Symbol	Value	Unit
Supply Voltage	V_{CC}	6.0	Vdc
RF Input Power	P_{RF}	10	dBm
Power Dissipation	P_{DIS}	100	mW
Supply Current	I_{CC}	20	mA
Thermal Resistance, Junction to Case	$R_{\theta JC}$	400	C/W
Storage Temperature Range	T_{stg}	-65 to 150	$^\circ\text{C}$
Operating Case Temperature	T_C	-40 to 100	$^\circ\text{C}$

- NOTES:** 1. Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the limits in the Recommended Operating Conditions and Electrical Characteristics tables.
2. ESD (electrostatic discharge) immunity meets Human Body Model (HBM) ≤ 500 V and Machine Model (MM) ≤ 50 V. Additional EST data available upon request.

RECOMMENDED OPERATING CONDITIONS

Characteristic	Symbol	Min	Typ	Max	Unit
RF Frequency	f_{RF}	100	—	2500	MHz
Supply Voltage	V_{CC}	2.7	—	5.0	Vdc

DEVICE LEVEL CHARACTERISTICS ($V_{CC} = 2.7$ V, $T_A = 25^\circ\text{C}$, measured in S-parameter test fixture, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Insertion Gain f = 900 MHz f = 1900 MHz	$ S_{21} ^2$	— —	16.5 10	— —	dB
Maximum Stable Gain and/or Minimum Available Gain [Note 1] f = 900 MHz f = 1900 MHz	MSG, MAG	— —	24.5 14.3	— —	dB
Minimum Noise Figure [Note 2] f = 900 MHz f = 1900 MHz	NF_{min}	— —	0.9 1.9	— —	dB
Output Third Order Intercept Point [Note 3] f = 900 MHz f = 1900 MHz	OIP3	— —	16.5 17	— —	dBm
Reverse Isolation f = 900 MHz f = 1900 MHz	$ S_{12} ^2$	— —	-45 -31	— —	dB

NOTES: 1. Maximum Available Gain and Maximum Stable Gain are defined by the K factor as follows:

$$MAG = \left| \frac{S_{21}}{S_{12}} \left(K \pm \sqrt{K^2 - 1} \right) \right|, \text{ if } K > 1, \text{ MSG} = \left| \frac{S_{21}}{S_{12}} \right|, \text{ if } K < 1$$

2. Device matched for best noise figure.
3. Z_{out} matched for optimum IP3.

Freescale Semiconductor, Inc.

MBC13916

ELECTRICAL CHARACTERISTICS ($V_{CC} = 2.7$ V, $T_A = 25^\circ\text{C}$, $f_{RF} = 900$ MHz, Tested in Circuit Shown in Figure 1, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Small Signal Gain	S_{21}	17	19	21	dB
Noise Figure	NF	—	1.25	—	dB
Power Output at 1.0 dB Gain Compression	P_{1dB}	0	2.5	—	dBm
Output 3rd Order Intercept Point	OIP3	—	13	—	dBm
Reverse Isolation	S_{12}	—	-42	—	dB
Supply Current	I_{CC}	3.8	4.7	5.6	mA

Figure 1. 900 MHz Applications Circuit Configuration

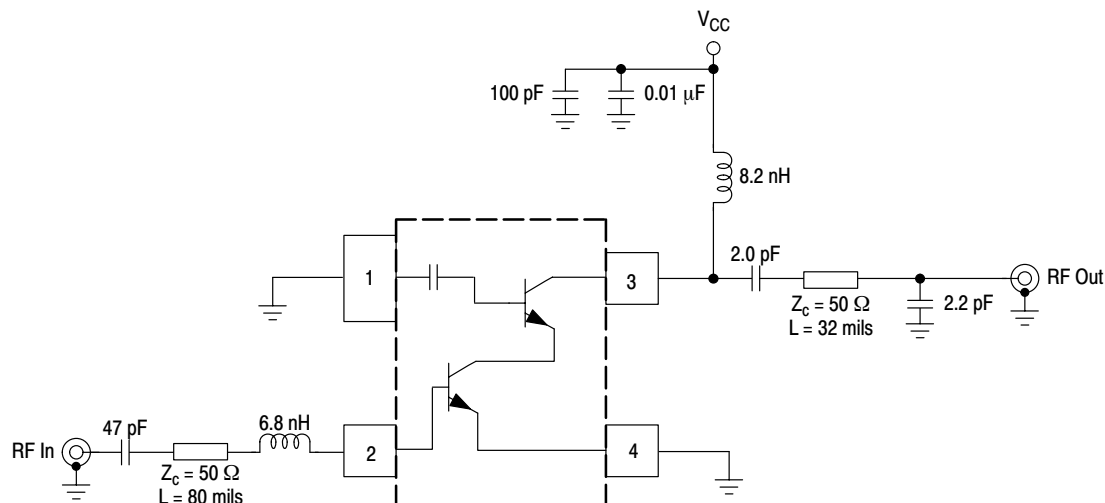
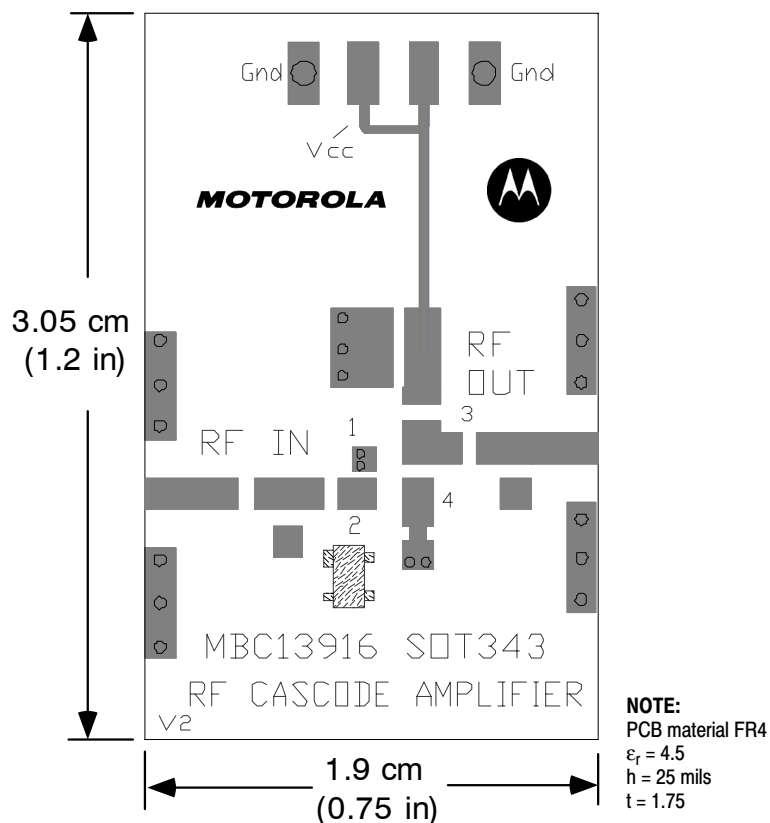


Figure 2. 900 MHz Printed Circuit Board



ELECTRICAL CHARACTERISTICS ($V_{CC} = 2.7\text{ V}$, $T_A = 25^\circ\text{C}$, $f_{RF} = 1.9\text{ GHz}$, Tested in Circuit Shown in Figure 3, unless otherwise noted.)

Characteristic	Symbol	Min	Typ	Max	Unit
Small Signal Gain	S_{21}	9.5	11.5	13.5	dB
Noise Figure	NF	—	2.1	—	dB
Power Output at 1.0 dB Gain Compression	P_{1dB}	—	-4.0	—	dBm
Output 3rd Order Intercept Point	OIP3	—	5.5	—	dBm
Reverse Isolation	S_{12}	—	-28	—	dB
Supply Current	I_{CC}	3.8	4.7	5.6	mA

Figure 3. 1.9 GHz Application Configuration Circuit

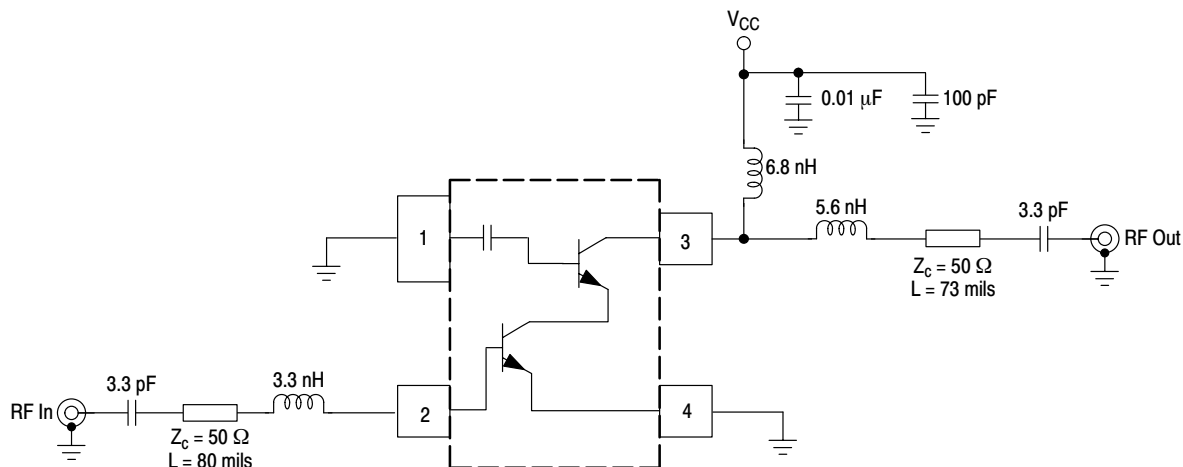


Figure 4. 1900 MHz Printed Circuit Board

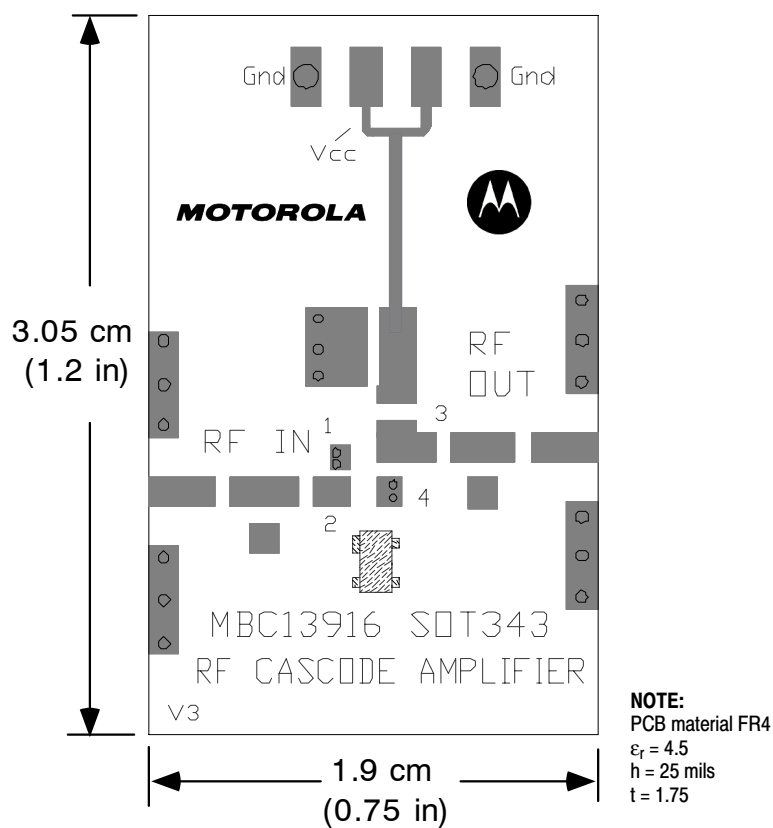


Figure 5. GUmux versus Frequency

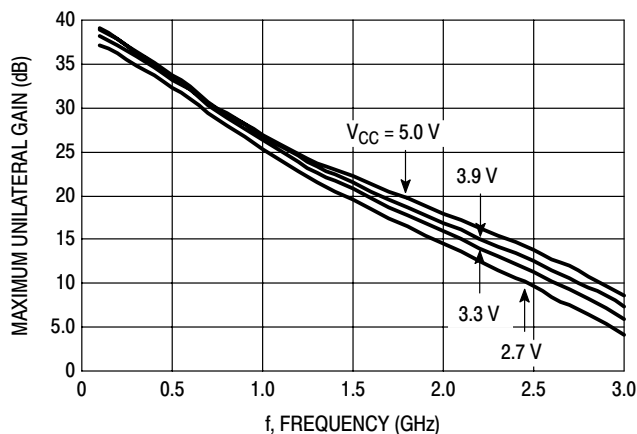


Figure 6. Output Power versus Input Power

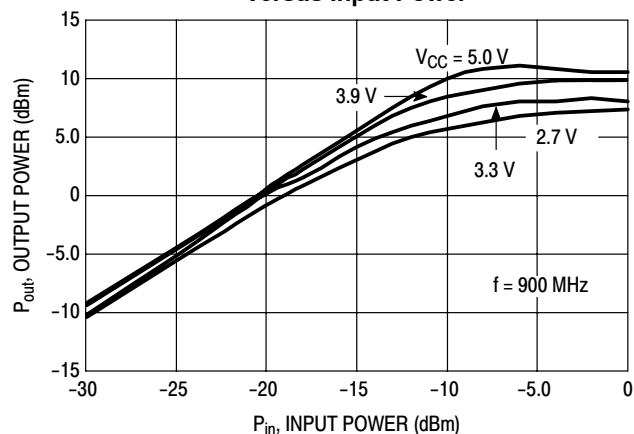


Figure 7. Output Power versus Input Power

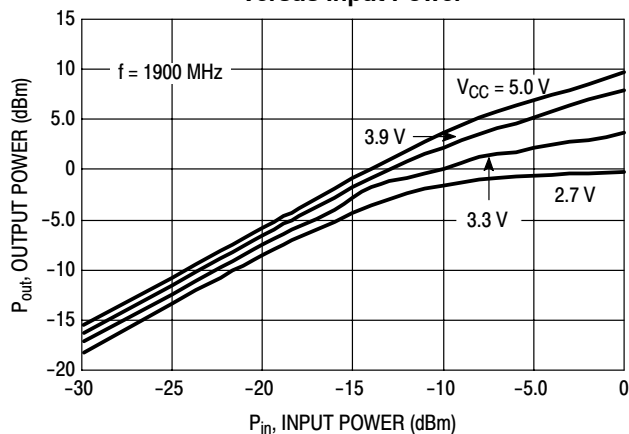


Figure 8. Supply Current versus Input Power

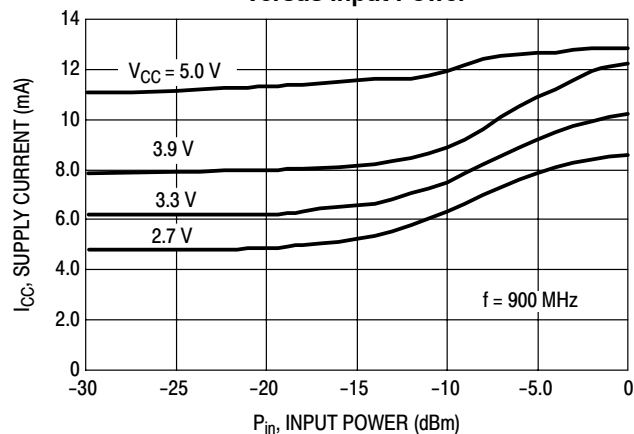


Figure 9. Supply Current versus Input Power

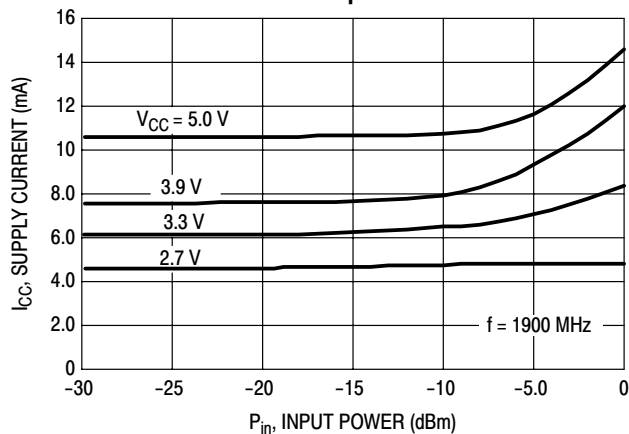


Table 1. Scattering Parameters
($V_{CC} = 2.7\text{ V}$, $50\ \Omega$ System)

f (MHz)	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	S ₁₁	$\angle \phi$	S ₂₁	$\angle \phi$	S ₁₂	$\angle \phi$	S ₂₂	$\angle \phi$
100	0.829	-11	11.98	165	0.001	17	0.955	-4
200	0.798	-21	11.43	152	0.002	47	0.957	-7
300	0.753	-31	10.69	139	0.002	55	0.956	-11
400	0.701	-39	10.12	128	0.003	56	0.955	-14
500	0.648	-46	9.28	118	0.003	51	0.955	-18
600	0.599	-53	8.66	108	0.004	49	0.954	-22
700	0.554	-58	7.95	98	0.004	41	0.947	-26
800	0.518	-61	7.33	90	0.004	24	0.941	-30
900	0.485	-65	6.83	82	0.004	15	0.933	-34
1000	0.458	-67	6.23	74	0.004	-4	0.926	-38
1100	0.438	-69	5.78	67	0.004	-28	0.915	-43
1200	0.426	-71	5.39	60	0.005	-50	0.902	-46
1300	0.417	-72	4.97	52	0.006	-74	0.893	-51
1400	0.414	-73	4.59	46	0.008	-93	0.879	-54
1500	0.415	-74	4.31	39	0.011	-106	0.868	-58
1600	0.421	-75	3.99	32	0.014	-115	0.851	-62
1700	0.430	-76	3.66	25	0.018	-125	0.835	-66
1800	0.441	-78	3.43	19	0.022	-131	0.818	-70
1900	0.455	-80	3.16	12	0.027	-139	0.803	-73
2000	0.474	-82	2.93	5	0.033	-146	0.777	-77
2100	0.490	-85	2.70	-1	0.039	-152	0.761	-81
2200	0.504	-88	2.48	-8	0.045	-159	0.735	-85
2300	0.524	-92	2.27	-14	0.052	-163	0.707	-89
2400	0.542	-95	2.09	-21	0.059	-169	0.683	-93
2500	0.559	-98	1.90	-28	0.067	-175	0.651	-98
2600	0.572	-103	1.70	-34	0.075	180	0.624	-102
2700	0.587	-106	1.56	-40	0.083	174	0.593	-107
2800	0.603	-110	1.40	-48	0.091	169	0.562	-111
2900	0.610	-114	1.26	-55	0.098	163	0.533	-116
3000	0.613	-118	1.11	-60	0.105	160	0.501	-120

Table 2. Scattering Parameters
($V_{CC} = 3.0 \text{ V}$, 50Ω System)

f (MHz)	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	S ₁₁	$\angle \phi$	S ₂₁	$\angle \phi$	S ₁₂	$\angle \phi$	S ₂₂	$\angle \phi$
100	0.812	-11	13.42	165	0.001	11	0.954	-3
200	0.778	-21	12.73	151	0.001	50	0.955	-7
300	0.731	-30	11.82	138	0.002	58	0.956	-11
400	0.677	-38	11.10	127	0.003	50	0.954	-14
500	0.623	-44	10.12	116	0.003	51	0.954	-18
600	0.575	-50	9.37	107	0.003	43	0.952	-22
700	0.533	-54	8.56	98	0.003	30	0.945	-26
800	0.499	-57	7.85	90	0.004	24	0.937	-30
900	0.470	-59	7.29	82	0.004	8	0.930	-34
1000	0.448	-61	6.63	74	0.003	-11	0.923	-38
1100	0.433	-63	6.14	67	0.004	-38	0.911	-42
1200	0.423	-64	5.72	60	0.005	-58	0.900	-46
1300	0.418	-65	5.27	53	0.006	-77	0.891	-50
1400	0.421	-66	4.87	47	0.008	-96	0.878	-54
1500	0.425	-67	4.56	40	0.011	-108	0.868	-58
1600	0.432	-68	4.23	34	0.014	-120	0.852	-61
1700	0.444	-70	3.89	27	0.018	-126	0.838	-65
1800	0.459	-72	3.63	21	0.022	-133	0.822	-69
1900	0.473	-74	3.35	15	0.027	-140	0.809	-73
2000	0.490	-77	3.12	8	0.033	-147	0.784	-77
2100	0.509	-80	2.87	2	0.039	-152	0.769	-80
2200	0.527	-83	2.64	-5	0.045	-159	0.744	-84
2300	0.545	-86	2.42	-11	0.051	-163	0.717	-88
2400	0.560	-90	2.23	-17	0.059	-170	0.694	-92
2500	0.579	-94	2.03	-24	0.067	-175	0.663	-97
2600	0.594	-98	1.82	-30	0.075	-180	0.637	-101
2700	0.606	-101	1.68	-36	0.083	175	0.607	-105
2800	0.620	-105	1.50	-43	0.090	169	0.576	-110
2900	0.630	-110	1.35	-50	0.097	164	0.548	-114
3000	0.636	-113	1.19	-55	0.105	160	0.516	-119

($V_{CC} = 3.3 \text{ V}$, 50Ω System)

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Table 4. Scattering Parameters
($V_{CC} = 3.9 \text{ V}$, 50Ω System)

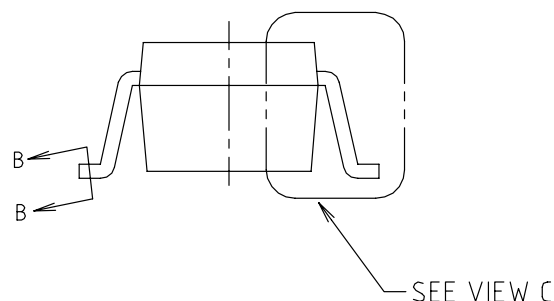
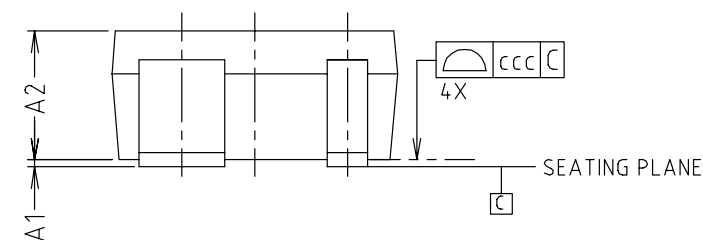
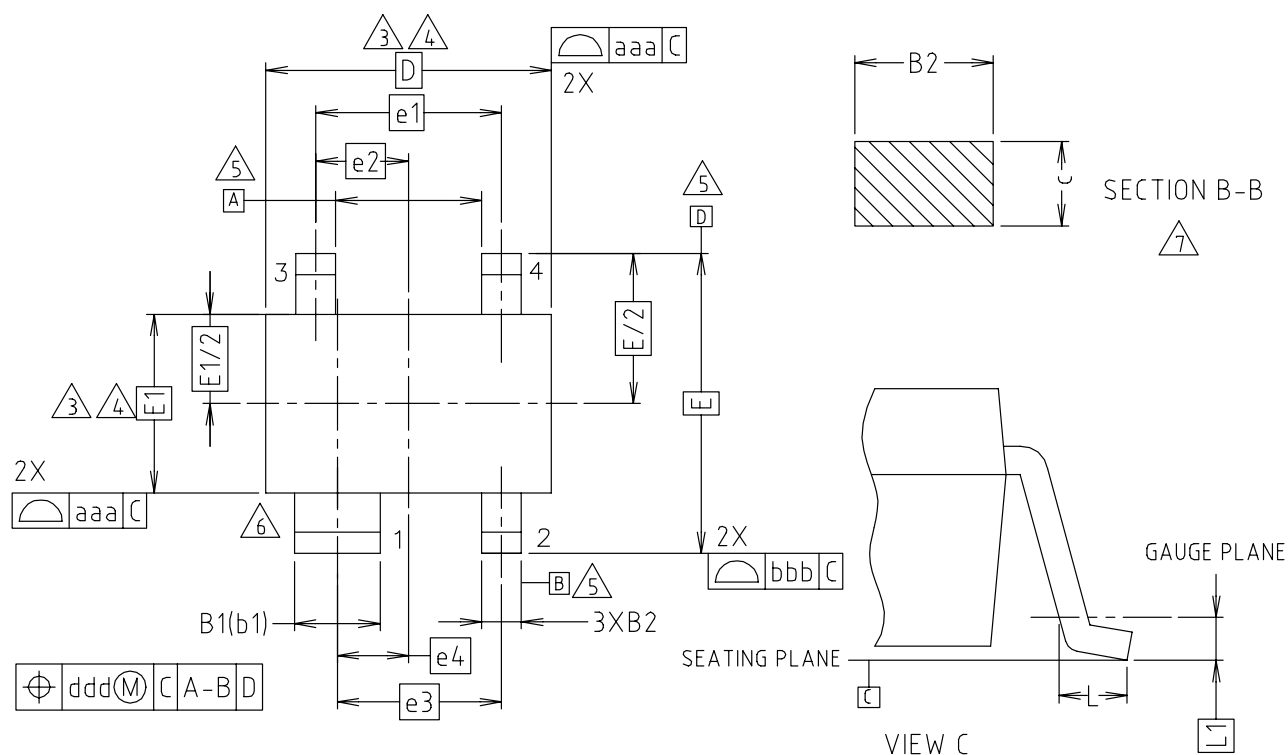
f (MHz)	S ₁₁		S ₂₁		S ₁₂		S ₂₂	
	S ₁₁	$\angle \phi$	S ₂₁	$\angle \phi$	S ₁₂	$\angle \phi$	S ₂₂	$\angle \phi$
100	0.768	-10	17.37	163	0.001	5	0.951	-3
200	0.728	-19	16.21	148	0.001	44	0.952	-7
300	0.676	-27	14.75	135	0.002	39	0.953	-11
400	0.621	-33	13.55	124	0.002	44	0.952	-14
500	0.573	-37	12.13	113	0.002	55	0.952	-18
600	0.532	-41	11.07	104	0.003	41	0.951	-22
700	0.498	-43	9.96	96	0.003	36	0.943	-26
800	0.477	-45	9.06	88	0.003	20	0.937	-29
900	0.461	-46	8.36	81	0.002	13	0.930	-33
1000	0.448	-47	7.56	74	0.002	-25	0.925	-37
1100	0.442	-48	6.97	68	0.003	-54	0.914	-41
1200	0.444	-49	6.48	62	0.005	-75	0.903	-45
1300	0.448	-50	5.95	54	0.006	-94	0.895	-49
1400	0.455	-51	5.50	49	0.008	-107	0.883	-52
1500	0.465	-53	5.15	43	0.011	-113	0.875	-56
1600	0.480	-55	4.77	37	0.014	-122	0.860	-60
1700	0.495	-56	4.39	32	0.018	-130	0.847	-63
1800	0.507	-59	4.11	26	0.022	-136	0.834	-67
1900	0.525	-62	3.80	20	0.027	-142	0.821	-71
2000	0.546	-65	3.54	14	0.032	-148	0.799	-74
2100	0.565	-67	3.28	8	0.038	-153	0.785	-78
2200	0.578	-71	3.02	2	0.044	-160	0.763	-82
2300	0.598	-75	2.78	-3	0.051	-163	0.739	-85
2400	0.617	-79	2.57	-9	0.059	-169	0.719	-90
2500	0.633	-82	2.36	-15	0.066	-174	0.690	-94
2600	0.645	-86	2.12	-21	0.073	-179	0.666	-98
2700	0.660	-90	1.96	-27	0.082	176	0.639	-103
2800	0.678	-94	1.76	-33	0.089	171	0.609	-107
2900	0.683	-98	1.59	-39	0.097	165	0.583	-112
3000	0.683	-102	1.42	-44	0.105	162	0.553	-116

($V_{CC} = 5.0\text{ V}$, $50\ \Omega$ System)

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OUTLINE DIMENSIONS

PLASTIC PACKAGE
SOT-343R



SYMBOL	MILLIMETERS			NOTE	SYMBOL	TOLERANCES OF FORM AND POSITION		NOTE
	MINIMUM	NOMINAL	MAXIMUM					
A1	0.00	—	0.10		aaa	0.15		
A2	0.80	0.90	1.00		bbb	0.20		
B1	0.55	—	0.70		ccc	0.10		
B2	0.25	—	0.40		ddd	0.10		
c	0.10	—	0.25					
D		2.00 BSC		3,4				
E		2.10 BSC						
E1		1.25 BSC		3,4				
e1		1.30 BSC						
e2		0.65 BSC						
e3		1.15 BSC						
e4		0.50 BSC						
L	0.25	—	—					
L1		0.15 BSC						

NOTE:

1. DIMENSIONS IN MILLIMETERS.



DIMENSION D DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15mm PER END. DIMENSION E1 DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.15mm PER SIDE.



DIMENSIONS D AND E1 ARE DETERMINED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.



DATUMS A, B AND D TO BE DETERMINED 0.10mm FROM THE LEAD TIP.



TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.



THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN 0.08mm AND 0.15mm FROM THE LEAD TIP.

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MOTOROLA

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